# **End of Line programmable 3-Wire Hall Effect Latch/Switch**Datasheet



#### 1 Features and Benefits

- Programmable parameters in application:
  - Wide magnetic Latch range: ±0.4mT to ±80mT
  - Wide magnetic Switch range: ±1.5mT to ±66mT
  - Programmable Hysteresis: 1mT to 36mT
  - Programmable Active Pole: North or South
- Programmable Output Behaviour: Direct or Inverted
- Increased Traceability: 32 bits ID on chip
- Built-in Negative TC coefficient: 0 to -2000 ppm/°C
- Wide operating voltage range: from 2.7V to 24V
- Reverse Supply Voltage Protection
- Output Current Limit with Auto-Shutoff
- Under-Voltage Lockout Protection
- Thermal Protection
- Lateral Sensitivity option
- Dual die option

# 2 Application Examples

- Automotive, Consumer and Industrial
- Solid-state switch
- 3-phase BLDC motor commutation
- Wiper motor
- Window lifter
- Sunroof/Tailgate opener
- Seat motor adjuster
- Electrical power steering
- Brake Light switch

# 3 Ordering Information

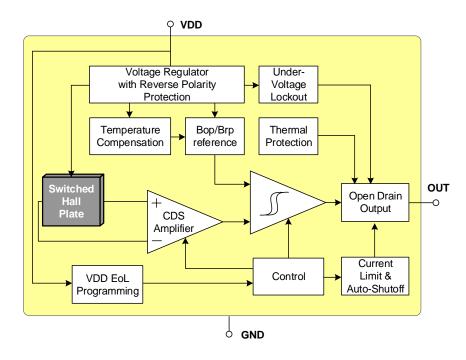
Product Code	Temperature Code	Package Code	Comment
MLX92232LSE-AAA-000-RE	L (-40°C to 150°C)	SE (TSOT-3L)	3-wire Switch/Latch, TC=0 ppm/°C
MLX92232LUA-AAA-000-BU	L (-40°C to 150°C)	UA (TO92-3L)	3-wire Switch/Latch, TC=0 ppm/°C
MLX92232LVA-AAA-000-BU	L (-40°C to 150°C)	VA (SIP 4L)	Dual Die 3-wire Switch/Latch, TC=0 ppm/°C
MLX92232LSE-AAA-001-RE	L (-40°C to 150°C)	SE (TSOT-3L)	3-wire Switch/Latch, TC=-400 ppm/°C
MLX92232LUA-AAA-001-BU	L (-40°C to 150°C)	UA (TO92-3L)	3-wire Switch/Latch, TC=-400 ppm/°C
MLX92232LSE-AAA-002-RE	L (-40°C to 150°C)	SE (TSOT-3L)	3-wire Switch/Latch, TC=-1100 ppm/°C
MLX92232LUA-AAA-002-BU	L (-40°C to 150°C)	UA (TO92-3L)	3-wire Switch/Latch, TC=-1100 ppm/°C
MLX92232LSE-AAA-003-RE	L (-40°C to 150°C)	SE (TSOT-3L)	3-wire Switch/Latch, TC=-2000 ppm/°C
MLX92232LUA-AAA-003-BU	L (-40°C to 150°C)	UA (TO92-3L)	3-wire Switch/Latch, TC=-2000 ppm/°C
MLX92232LSE-AAA-200-RE	L (-40°C to 150°C)	SE (TSOT-3L)	3-wire Switch/Latch IMC version, TC=0 ppm/°C
MLX92232LSE-AAA-201-RE	L (-40°C to 150°C)	SE (TSOT-3L)	3-wire Switch/Latch IMC version, TC=-400 ppm/°C
MLX92232LSE-AAA-202-RE	L (-40°C to 150°C)	SE (TSOT-3L)	3-wire Switch/Latch IMC version, TC=-1100 ppm/°C
MLX92232LSE-AAA-203-RE	L (-40°C to 150°C)	SE (TSOT-3L)	3-wire Switch/Latch IMC version, TC=-2000 ppm/°C
MLX92232LUA-AAA-200-BU	L (-40°C to 150°C)	UA (TO92-3L)	3-wire Switch/Latch IMC version, TC=0 ppm/°C

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## 5 General Description

The Melexis MLX92232 is the second generation programmable Hall-effect sensor designed in mixed signal CMOS technology. The device integrates a voltage regulator, Hall sensor with advanced offset cancellation system and an opendrain output driver, all in a single package.

With the built-in reverse voltage protection, a serial resistor or diode on the supply line is not required so that even remote sensors can be specified for low voltage operation down to 2.7V while being reverse voltage tolerant. In the event of a drop below the minimum supply voltage during operation, the under-voltage lock-out protection will automatically freeze the device, preventing the electrical perturbation to affect the magnetic measurement circuitry.

The open drain output is fully protected against short-circuit with a built-in current limit. An additional automatic output shut-off is activated in case of a prolonged short-circuit condition. A self-check is then periodically performed to switch back to normal operation if the short-circuit condition is released.

The on-chip thermal protection also switches off the output if the junction temperature increases above an abnormally high threshold. It will automatically recover once the temperature decreases below a safe value.

Furthermore the MLX92232 features a full set of programmable parameters that can be adjusted in the application in order to achieve the highest possible system accuracy by compensating the mechanical tolerances.

An Integrated Magnetic Concentrator option (IMC) has been added to sense the lateral field component. This is adding more flexibility in the module design. A dual die option is also available for applications that need a secondary output; these can be programmed independently from each other.

# End of Line programmable 3-Wire Hall Effect Latch/Switch



#### Datasheet

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# **6** Glossary of Terms

Tesla Units for the magnetic flux density, 1 mT = 10 Gauss

TC Temperature Coefficient in ppm/°C IMC Integrated Magnetic Concentrator

POR Power on Reset

# 7 Absolute Maximum Ratings

Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

Parameter	Symbol	Value	Units
Supply Voltage (1, 2)	$V_{\text{DD}}$	+27	V
Supply Voltage (Load Dump) (1, 4)	$V_{DD}$	+32	V
Supply Current (1, 2, 3)	$I_{DD}$	+20	mA
Supply Current (1, 3, 4)	$I_{DD}$	+50	mA
Reverse Supply Voltage (1, 2)	$V_{\text{DDREV}}$	-24	V
Reverse Supply Voltage (1, 4)	$V_{DDREV}$	-30	V
Reverse Supply Current (1, 2, 5)	I <sub>DDREV</sub>	-20	mA
Reverse Supply Current (1, 4, 5)	I <sub>DDREV</sub>	-50	mA
Output Voltage (1, 2)	Vout	+27	V
Output Current (1, 2, 5)	Гоит	+20	mA
Output Current (1, 4, 6)	Гоит	+75	mA
Reverse Output Voltage (1)	Voutrev	-0.5	V
Reverse Output Current (1, 2)	I <sub>OUTREV</sub>	-100	mA
Maximum Junction Temperature (7)	TJ	+165	°C
Storage Temperature Range	Ts	-55 to +165	°C
ESD Sensitivity – HBM <sup>(8)</sup>	-	4000	V
ESD Sensitivity – CDM <sup>(9)</sup>	-	1000	V
Magnetic Flux Density	В	Unlimited	mT

<sup>1</sup> The maximum junction temperature should not be exceeded

<sup>2</sup> For maximum 1 hour

<sup>3</sup> Including current through protection device

<sup>4</sup> For maximum 500ms

<sup>5</sup> Through protection device

<sup>6</sup> For V<sub>OUT</sub>≤27V

<sup>7</sup> For 1000 hours

<sup>8</sup> Human Model according AEC-Q100-002 standard

<sup>9</sup> Charged Device Model according AEC-Q100-011 standard

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# **General Electrical Specifications**

DC Operating Parameters V<sub>DD</sub> = 2.7V to 24V, T<sub>A</sub> = -40°C to 150°C (unless otherwise specified)

		`	· ′			
Parameter	Symbol	Test Conditions	Min	Typ <sup>(1)</sup>	Max	Units
Supply Voltage	$V_{\text{DD}}$	Operating	2.7	-	24	V
Supply Current (2)	$I_{DD}$		1.5	3.0	4.5	mA
Supply Current (3)	$I_{DD}$		3.0	6.0	9.0	mA
Reverse supply current	$I_{\text{DDREV}}$	V <sub>DD</sub> = -16V	-1	-	-	mA
Output Saturation Voltage	$V_{DSON}$	$V_{DD}$ = 3.5 to 24V, $I_{OUT}$ = 20mA	-	0.3	0.5	V
Output Leakage	$I_{OFF}$	$V_{OUT} = 12V$ , $V_{DD} = 12V$	-	-	10	μΑ
Output Rise Time (4, 8) (R <sub>PU</sub> dependent)	$t_R$	$R_{PU} = 1k\Omega$ , $V_{DD} = 12V$ , $V_{PU} = 5V$ $C_{LOAD} = 50pF$ to GND	0.1	0.3	1	μs
Output Fall Time (4,8) (On-chip controlled)	t <sub>F</sub>	$R_{PU} = 1k\Omega$ , $V_{DD} = 12V$ , $V_{PU} = 5V$ $C_{LOAD} = 50pF$ to GND	0.1	0.3	1	μs
Power-On Time (5,6,9)	t <sub>ON</sub>	$V_{DD} = 5V$ , $dV_{DD}/dt > 2V/us$	-	40	70	μs
Power-On Output State	-	t < t <sub>ON</sub>		$High \ (V_{PU})$		-
Output Current Limit	$I_{CL}$	$V_{DD}$ =3.5 to 24V, $V_{OUT}$ = 12V	25	40	70	mA
Output ON Time under Current Limit conditions <sup>(10)</sup>	t <sub>CLON</sub>	$V_{PU}$ = 12V, $R_{PU}$ = 100 $\Omega$	150	240		μs
Output OFF Time under Current Limit conditions <sup>(10)</sup>	$t_{\text{CLOFF}}$	$V_{PU}$ = 12V, $R_{PU}$ = 100 $\Omega$	-	3.5	-	ms
Chopping Frequency	$f_{\text{CHOP}}$		-	340	-	kHz
Refresh Period	$t_{PER}$		-	6	-	μs
Output Jitter (p-p) (4)	t <sub>JITTER</sub>	Over 1000 successive switching events @10kHz triangle wave magnetic field, B > ±(B <sub>OPMAX</sub> +20mT)	-	±3.2	-	μs
Maximum Switching Frequency (4, 7)	$f_{\text{SW}}$	$B > \pm 3(B_{OPMAX} + 1mT)$ , triangle wave magnetic field	30	65	-	kHz
Under-voltage Lockout Threshold	$V_{\text{UVL}}$		-	-	2.7	V
Under-voltage Lockout Reaction time (4)	$t_{\text{UVL}}$		-	1	-	μs
Thermal Protection Threshold	$T_{PROT}$	Junction temperature	-	190(11)	-	°C
Thermal Protection Release	$T_REL$	Junction temperature	-	180(11)	-	°C
SE Package Thermal Resistance	R <sub>THJA</sub>	Single layer PCB, JEDEC standard test boards		300		°C/W
UA package Thermal Resistance	$R_{THJA}$	Single layer PCB, JEDEC standard test boards		200		°C/W
VA package Thermal Resistance	R <sub>THJA</sub>	Single layer PCB, JEDEC standard test boards		105		°C/W

<sup>1</sup> Typical values are defined at  $T_A = +25$ °C and  $V_{DD} = 12V$ 

<sup>2</sup> Valid for 92232LSE-AAA-xxx and 92232LUA-AAA-xxx versions

<sup>3</sup> Valid for 92232LVA-AAA-xxx version

<sup>4</sup> Guaranteed by design and verified by characterization, not production tested

<sup>5</sup> The Power-On Time represents the time from reaching  $V_{DD}$  = 2.7V to the first refresh of the output

<sup>6</sup> Power-On Slew Rate is not critical for the proper device start-up.

<sup>7</sup> Maximum switching frequency corresponds to the maximum frequency of the applied magnetic field which is detected without loss of pulses

<sup>8</sup>  $R_{PU}$  and  $V_{PU}$  are respectively the external pull-up resistor and pull-up power supply

<sup>9</sup> Activated output with 1 mT overdrive

<sup>10</sup> If the Output is in Current Limitation longer than  $t_{CLON}$  the Output is switched off in high-impedance state. The Output returns back in active state at next reaching of  $B_{OP}$  or after  $t_{CLOFF}$  time interval

<sup>11</sup>  $T_{PROT}$  and  $T_{REL}$  are the corresponding junction temperature values

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# 9 Magnetic Specifications

DC Operating Parameters V<sub>DD</sub> = 2.7V to 24V, T<sub>A</sub> = -40°C to 150°C (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ <sup>(1)</sup>	Max	Units
Latch Threshold Programming Range <sup>(2, 3)</sup>	B <sub>LTH</sub>	V <sub>DD</sub> =12V, T <sub>A</sub> =25°C	±0.4		±80	mT
Switch Operating Point Programming Range <sup>(3, 4)</sup>	Вор	V <sub>DD</sub> =12V, T <sub>A</sub> =25°C	±1.5		±66	mT
Proportional Hysteresis Ratio Programming (5, 6)	HYS <sub>RATIO</sub>	$V_{DD}$ =12V, $T_A$ =25°C	0.1		0.55	-
Fixed Hysteresis Value 0 <sup>(7, 8)</sup>	B <sub>FHYS0</sub>		-	0	-	mT
Fixed Hysteresis Value 1 <sup>(7,8)</sup>	B <sub>FHYS1</sub>		-	1	-	mT
Fixed Hysteresis Value 2 <sup>(7, 8)</sup>	B <sub>FHYS2</sub>		-	1.2	-	mT
Fixed Hysteresis Value 3 <sup>(7, 8)</sup>	B <sub>FHYS3</sub>		-	1.4	-	mT
Fixed Hysteresis Value 4 <sup>(7, 8)</sup>	B <sub>FHYS4</sub>		-	1.8	-	mT
Fixed Hysteresis Value 5 <sup>(7, 8)</sup>	B <sub>FHYS5</sub>		-	2.2	-	mT
Latch Sensor Magnetic Offset <sup>(9)</sup>	D	T <sub>A</sub> =25°C	-0.5		0.5	mT
Later Sensor Magnetic Offset	Boffset	T <sub>A</sub> =-40°C to 150°C	-0.9		0.9	mT
Temperature Coefficient <sup>(10)</sup>	TC	Latch with: No IMC: $B_{OP}/B_{RP} = +-28mT$ IMC: $B_{OP}/B_{RP} = +-12mT$		0 -400 -1100 -2000		ppm/°C
Factory Programmed B <sub>OP</sub> , Switch <sup>(11)</sup>	B <sub>OP</sub>	$V_{DD}$ =12V, $T_A$ =25°C, target 28mT	26	28	30	mT
Factory Programmed B <sub>RP</sub> , Switch <sup>(11)</sup>	B <sub>RP</sub>	V <sub>DD</sub> =12V, T <sub>A</sub> =25°C, target 28mT, HYS <sub>RATIO</sub> =0.25	19	21	23	mT
Factory Programmed B <sub>OP</sub> , Latch <sup>(12)</sup>	Вор	$V_{DD}$ =12V, $T_A$ =25°C, target 12mT	10	12	14	mT
Factory Programmed B <sub>RP</sub> , Latch <sup>(12)</sup>	$B_RP$	$V_{DD}$ =12V, $T_A$ =25°C, target -12mT	-14	-12	-10	mT

6 The given min/max limits are typical values.

7 For Switch sensor with fixed hysteresis value

8 Guaranteed by design and verified by characterization.

9 For Latch sensor offset is defined as  $B_{OFFSET} = (B_{OP} + B_{RP})/2$ .

10 The temperature Coefficient is calculated using following formula:

$$TC = \frac{B_{XPTA2} - B_{XPTA1}}{B_{XPT25} * (T_{A2} - T_{A1})} * 10^6, ppm/^{\circ}C$$

where:

 $T_{A1} = -40$ °C,  $T_{A2} = 150$ °C,  $T_{25} = 25$ °C

In case of magnetic Latch application:  $B_{XPTA1}$ ,  $B_{XPTA2}$  or  $B_{XPT25} = B_{OP}$ - $B_{RP}$  at  $T_{A1}$ ,  $T_{A2}$  or  $T_{25}$ . In case of magnetic Switch application:  $B_{XPTA1}$ ,  $B_{XPTA2}$  or  $B_{XPT25} = B_{OP}$  or  $B_{RP}$  at  $T_{A1}$ ,  $T_{A2}$  or  $T_{25}$ .

11 Valid for 92232Lxx-AAA-0xx

12 Valid for 92232Lxx-AAA-2xx

<sup>1</sup> The typical values are defined at  $T_A$  = 25°C and  $V_{DD}$  = 12V.

<sup>2</sup> For Latch sensor  $B_{LTH} = (B_{OP} - B_{RP})/2$ . The Latch programming step is typically between 0.7% and 1.5% of the programmed  $B_{LTH}$  value for  $|B_{LTH}| \ge 1.2$ mT and 0.018mT for  $|B_{LTH}| \le 1.2$ mT.

<sup>3</sup> Guaranteed by design and verified by characterization. The programming ranges for BLTH and BOP include some margin for process deviations.

 $<sup>4 \, \</sup>text{For Switch sensor the} \, B_{\text{OP}} \, \text{programming step is typically between 0.7\% and 1.5\% of the programmed} \, B_{\text{OP}} \, \text{value for} \, |\, B_{\text{OP}}| \geq 4.8 \, \text{mT} \, \text{and 0.072} \, \text{mT for} \, |\, B_{\text{OP}}| \leq 4.8 \, \text{mT} \, \text{mT} \, \text{mT} \, \text{m} \, \text{mT} \, \text{m} \, \text{m$ 

<sup>5</sup> For Switch sensor with proportional hysteresis HYS<sub>RATIO</sub>=B<sub>HYS</sub>/B<sub>OP</sub>. The HYS<sub>RATIO</sub> programming step is 0.05.

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**10 Programming parameters** 

Parameter	Symbol	Comments	Value	Units
$B_{\text{op}}$ programming resolution	BOPFINE	Fine programming of the threshold $B_{\text{op}}$ (switch) and $B_{\text{LTH}}$ (Latch)	7	Bit
B <sub>op</sub> sub-range	Boprange	Selection of the appropriate switch sensor sub-range	2	Bit
B <sub>LTH</sub> sub-range	Boprange	Selection of the appropriate latch sensor sub-range	3	Bit
Programming hysteresis	Внуѕт	Hysteresis can be fixed or proportional	4	Bit
Active Pole selection	B <sub>POLE</sub>	Part can be programmed for south or north magnetic pole active	1	Bit
Output polarity selection	Pol <sub>OUT</sub>	Selects direct or inverted output polarity	1	Bit
Switch/Latch function selection		Selects Latch or Switch sensor function	1	Bit
Melexis programmed ID	ID	A unique fixed ID implemented for device traceability, no overwriting allowed.	32	Bit





South active pole (IMC version)

North active pole (IMC version)





South active pole

N



North active pole



South active pole

North active pole

## End of Line programmable 3-Wire Hall Effect Latch/Switch

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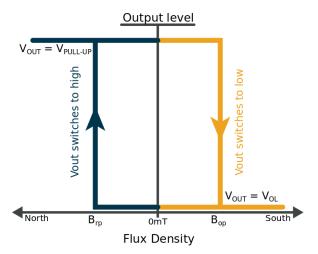




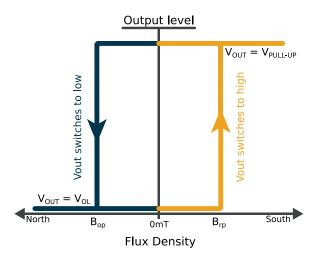
South pole active (VA package)

North pole active (VA package)

### 10.1 Latch Sensor



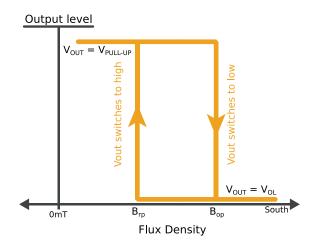




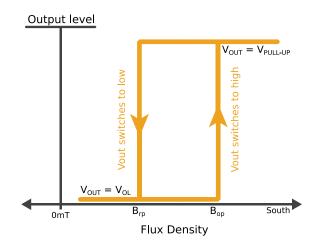
North Pole active



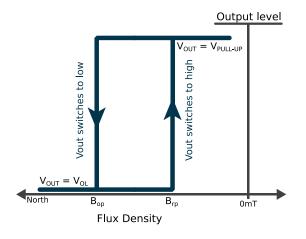
### 10.2 Switch Sensor



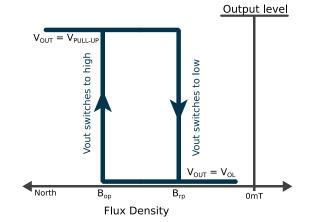




Inverted South Active Pole



Direct North Active Pole



Inverted North Active Pole

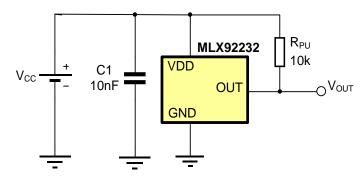
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# 11 Application Information

# 11.1 Typical Three-Wire Application Circuit

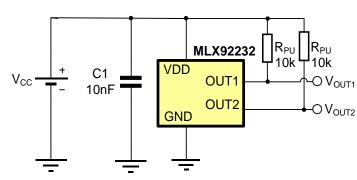
#### 11.1.1 92232LSE-AAA-xxx, 92232LUA-AAA-xxx



#### Notes:

- 1. For proper operation, a 10nF to 100nF bypass capacitor should be placed as close as possible to the  $V_{DD}$  and ground pin.
- 2. The pull-up resistor  $R_{PU}$  value should be chosen in to limit the current through the output pin below the maximum allowed continuous current for the device.
- 3. A capacitor connected to the output is not needed, because the output slope is generated internally.

#### 11.1.2 92232LVA-AAA-xxx



#### Notes:

- 1. For proper operation, a 10nF to 100nF bypass capacitor should be placed as close as possible to the  $\rm V_{\rm DD}$  and ground pin.
- $\bigcirc$   $V_{OUT1}$  2. The pull-up resistors  $R_{PU}$  values should be chosen in to limit the current through the output pin below the maximum allowed  $\bigcirc$   $V_{OUT2}$  continuous current for the device.
  - 3. A capacitors connected to the outputs are not needed, because the output slope is generated internally.

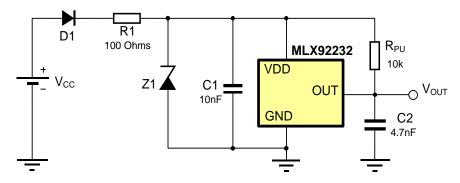
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Datasheet

#### 11.2 Automotive and Harsh, Noisy Environments Three-Wire Circuit

#### 11.2.1 92232LSE-AAA-xxx, 92232LUA-AAA-xxx



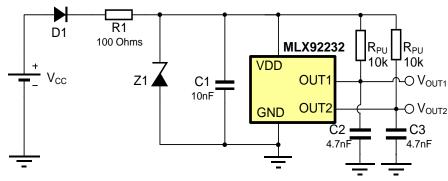
#### Notes:

- 1. For proper operation, a 10nF to 100nF bypass capacitor should be placed as close as possible to the  $V_{DD}$  and ground pin.
- 2. The device could tolerate negative voltage down to -24V, so if negative transients over supply line  $V_{PEAK}$ < -30V are expected, usage of the diode D1 is recommended. Otherwise only R1 is sufficient.

When selecting the resistor R1, three points are important:

- the resistor has to limit  $I_{\text{DD}}/I_{\text{DDREV}}$  to 50mA maximum
- the resistor has to withstand the power dissipated in both over voltage conditions (V<sub>R1</sub><sup>2</sup>/R1)
- the resulting device supply voltage  $V_{DD}$  has to be higher than  $V_{DD}$  min ( $V_{DD} = V_{CC} R1.I_{DD}$ )
- 3. The device could tolerate positive supply voltage up to +27V (until the maximum power dissipation is not exceeded), so if positive transients over supply line with  $V_{PEAK}$ > 32V are expected, usage a zener diode Z1 is recommended. The R1-Z1 network should be sized to limit the voltage over the device below the maximum allowed.

#### 11.2.2 92232LVA-AAA-xxx



#### Notes:

- 1. For proper operation, a 10nF to 100nF bypass capacitor should be placed as close as possible to the V<sub>DD</sub> and ground pin.
- 2. The device could tolerate negative voltage down to -24V, so if negative transients over supply line  $V_{PEAK}$ < -30V are expected, usage of the diode D1 is recommended. Otherwise only R1 is sufficient.

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- 3. The device could tolerate positive supply voltage up to +27V (until the maximum power dissipation is not exceeded), so if positive transients over supply line with  $V_{PEAK} > 32V$  are expected, usage a zener diode Z1 is recommended. The R1-Z1 network should be sized to limit the voltage over the device below the maximum allowed.

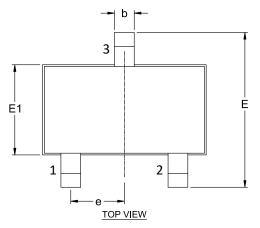
#### End of Line programmable 3-Wire Hall Effect Latch/Switch

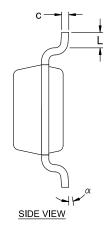
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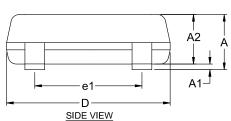
# 12 Package Information

# 12.1 TSOT-3L (SE Package)

#### 12.1.1 TSOT-3L - Package dimensions





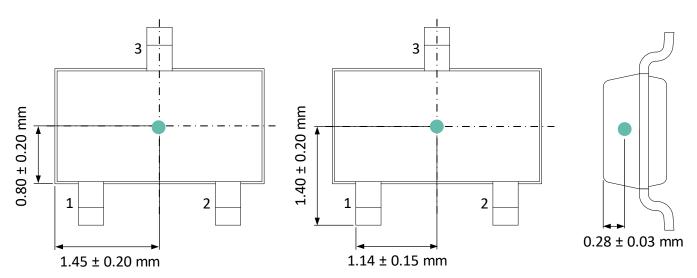


SYMBOL	MINIMUM	MAXIMUM	
Α		1.00	
A1	0.025	0.10	
A2	0.85	0.90	
D	2.80	3.00	
E	2.60	3.00	
E1	1.50	1.70	
L	0.30	0.50	
Ь	0.30	0.45	
U	0.10	0.20	
е	0.95	BSC	
e1	1.90	BSC	
α	0°	8°	

#### NOTE

- 1. ALL DIMENSIONS IN MILLIMETERS (mm) UNLESS OTHERWISE STATED.
- 2. DIMENSION D DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS OF MAX 0.15 mm PER SIDE.
- 3. DIMENSION E DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS OF MAX 0.25 mm PER SIDE.
- 4. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION OF MAX 0.07 mm.
- 5. DIMENSION L IS THE LENGTH OF THE TERMINAL FOR SOLDERING TO A SUBTRATE.
- 6. FORMED LEAD SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITH 0.076 mm SEATING PLANE.

#### 12.1.2 TSOT-3L – Sensitive spot







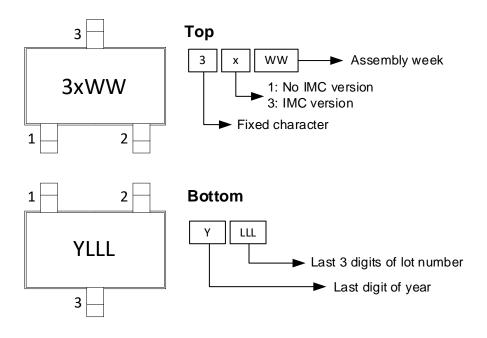


#### End of Line programmable 3-Wire Hall Effect Latch/Switch



# 12.1.3 TSOT-3L – Package marking / Pin definition





Pin #	Name	Туре	Function
1	VDD	Supply	Supply Voltage pin
2	OUT	Out	Open drain output pin
3	GND	Ground	Ground pin

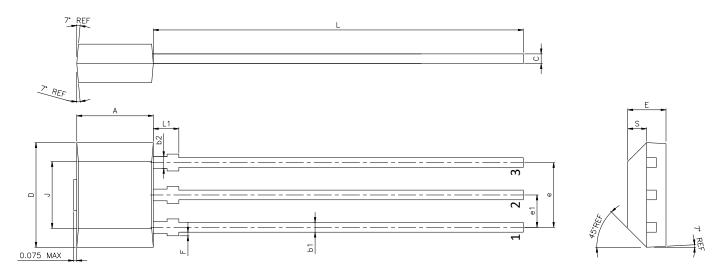
#### End of Line programmable 3-Wire Hall Effect Latch/Switch





# 12.2 TO92-3L (UA Package)

#### 12.2.1 TO92-3L - Package dimensions

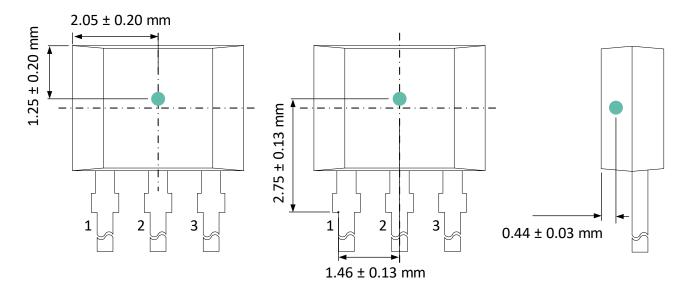


SYMBOL	MINIMUM	MAXIMUM	
Α	2.90	3.10	
D	4.00	4.20	
Ε	1.40	1.60	
F	0.00	0.15	
J	2.51	2.72	
L	14.00	15.00	
L1	0.90	1.10	
S	0.63	0.84	
b1	0.35	0.44	
b2	0.43	0.52	
С	0.35	0.44	
е	2.51	2.57	
e1	1.24	1.30	

#### NOTES:

- 1. DIMENSIONS IN MILLIMETERS (mm) UNLESS NOTED OTHERWISE.
- 2. PACKAGE DIMENSIONS DO NOT INCLUDE MOLD FLASHES AND PROTRUSIONS.
- 3. DIMENSION A AND D DO NOT INCLUDE MOLD GATE AND SIDE FLASH (PROTRUSION) of MAXIMUM 0.127 mm PER SIDE.
- 4. THE LEADS MAY BE SLIGHTLY DEFORMED DURING TRANSPORTATION IF PACKED IN BULK (BAG), AFFECTING e1 DIMENSION. IT IS RECOMMENDED TO ORDER RADIAL TAPE (REEL OR AMMOPACK) IF SUCH DEFORMATION IS CRITICAL FOR THE LEAD FORMING PROCESS, EVEN IF MANUAL LOADING INTO THE TOOL IS FORESEEN.

#### **12.2.2 TO92-3L – Sensitive spot**

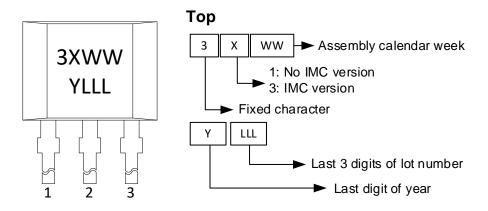


End of Line programmable 3-Wire Hall Effect Latch/Switch



### 12.2.3 TO92-3L – Package marking / Pin definition





Pin #	Name	Туре	Function
1	VDD	Supply	Supply Voltage pin
2	GND	Ground	Ground pin
3	OUT	Out	Open drain output pin

#### End of Line programmable 3-Wire Hall Effect Latch/Switch



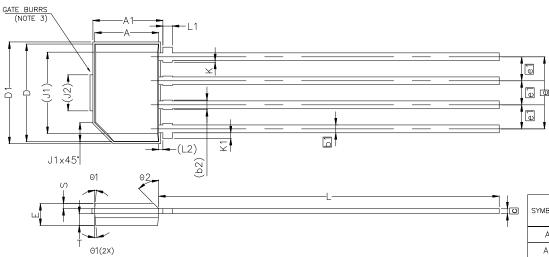


Θ2 (2X)

⊖1(2X)

# 12.3 VA Package

#### 12.3.1 VA – Package dimensions



#### Note

- 1. DIMENSIONS "A" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS AND GATE BURRS.
- 2. DIMENSIONS "A1" DOES NOT INCLUDE GATE BURRS BUT INCLUDES MOLD FLASH AT BOTH ENDS.
- 3. MOLD GATE BURRS SHALL NOT EXCEED 0.15 mm MEASURED FROM EDGE OF MOLD FLASH (FLANGE).
- 4. DIMENSION "D1" INCLUDES MOLD FLASH AT BOTH ENDS.
- 5. LEAD PLATING; MATTE TIN PLATING THICKNESS 7.62 15.42 um.

		-			
SYMBOLS	DIMENSIO	NS IN MIL	LIMETERS		
SIMBOLS	MIN	NOM	MAX		
А	3.30	3.38	3.46		
A1	3.63	3.70	3.79		
О	5.08	5.16	5.24		
D1	5.33	5.38	5.43		
E	1.10		1.20		
J	4.10	4.30	4.50		
J1		1.00 REF			
J2	1.906 REF				
K	0.00		0.15		
K1	0.25	0.30	0.35		
L	17.5	18.0	18.5		
L1	0.45	0.50	0.55		
L2		0.22 REF	•		
S	0.24		0.29		
T	0.61	-	0.66		
b1		0.42 BSC	>		
b2	0.50 REF				
С	0.25 BSC				
е	3.81 BSC				
e1	1.27 BSC				
Θ1	5° REF				
Θ2		45° REF			

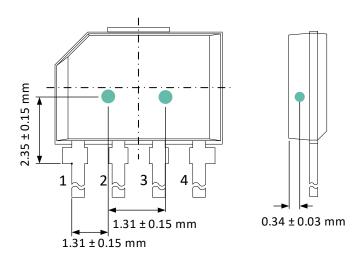
Θ1(2X)

# End of Line programmable 3-Wire Hall Effect Latch/Switch

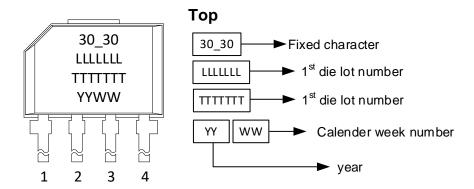
Datasheet

#### 12.3.2 VA – Sensitive Spot





### 12.3.3 VA – Package marking / Pin definition



Pin #	Name	Туре	Function
1	OUT1	Out	Open drain output pin
2	VDD	Supply	Supply Voltage pin
3	GND	Ground	Ground pin
4	OUT2	Out	Open drain output pin

**End of Line programmable 3-Wire Hall Effect Latch/Switch**Datasheet



## 13 IC handling and assembly

### 13.1 Storage and handling of plastic encapsulated ICs

Plastic encapsulated ICs shall be stored and handled according to their MSL categorization level (specified in the packing label) as per J-STD-033.

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD). The component assembly shall be handled in EPA (Electrostatic Protected Area) as per ANSI S20.20

For more information refer to Melexis Guidelines for storage and handling of plastic encapsulated ICs<sup>(1)</sup>

### 13.2 Assembly of encapsulated ICs

For Surface Mounted Devices (SMD, as defined according to JEDEC norms), the only applicable soldering method is reflow.

For Through Hole Devices (THD), the applicable soldering methods are reflow, wave, selective wave and robot point-to-point. THD lead pre-forming (cutting and/or bending) is applicable under strict compliance with Melexis *Guidelines for lead forming of SIP Hall Sensors*<sup>(1)</sup>.

Melexis products soldering on PCB should be conducted according to the requirements of IPC/JEDEC and J-STD-001. Solder quality acceptance should follow the requirements of IPC-A-610.

For PCB-less assembly refer to the relevant application notes (1) or contact Melexis.

Electrical resistance welding or laser welding can be applied to Melexis products in THD and specific PCB-less packages following the *Guidelines for welding of PCB-less devices*<sup>(1)</sup>.

Environmental protection of customer assembly with Melexis products for harsh media application, is applicable by means of coating, potting or overmolding considering restrictions listed in the relevant application notes (1)

For other specific process, contact Melexis via www.melexis.com/technical-inquiry

#### 13.3 Environment and sustainability

Melexis is contributing to global environmental conservation by promoting non-hazardous solutions. For more information on our environmental policy and declarations (RoHS, REACH...) visit www.melexis.com/environmental-forms-and-declarations

 ${\bf 1} \ www.melexis.com/ic\text{-}handling\text{-}and\text{-}assembly$ 

# **End of Line programmable 3-Wire Hall Effect Latch/Switch**Datasheet



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